## Type C2Q Surface Mount Very Fast-Acting Chip Fuse



**RoHS Compliant** 

#### **Features**

- Fast-acting
- Small size, 0603 SMD
- Current rating from 250mA to 5A
- Wide operating temperature range from -55°C to 125°C
- Tape and Reel for automatic SMD placement
- Compatible with 260°C IR Pb-free and wave soldering process
- Full compliance with EU Directive 2011/65/EU and amending directive 2015/863 (MSL = 1)
- Halogen Free and Lead Free



- NotebookLCD monitor
- PC computer
- Office electronic equipment
- Industrial equipment
- Medical equipment
- POE, POE+ LCD / LED monitor
- Power supply
- LCD / LED TV
- DC-DC Converter





#### **Electrical Characteristics** (UL STD.248-14)

Testing	Blow Time		
Current	Minimum	Maximum	
100%	4 Hrs.	N/A	
200%	N/A	5 Sec	
300%	N/A	0.2 Sec	

## **Safety Agency Approvals**

Safety Agency	Safety Agency Certificate	Ampere Rating/ Voltage Rating	Ampere Range / Volt @ I.R. ability*		
c <b>'711</b> ° us	E20624	250mA-4A/32V AC 63V DC	250mA-4A/32V AC @ 35A 63V DC @ 50A		
		5A / 32V AC & DC	5A / 32V AC & DC @ 50A		
*I.R.= Interrupting Rating = Short Circuit Rating(Amps)					

#### **Physical Specifications**

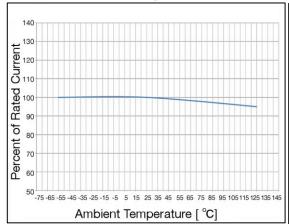
	Body : Ceramic Substrate
Materials	Terminations : Ag / Ni / Sn (100% Lead-free)
	Element Cover Coating : Lead-free Glass
	On Fuse :
	None
Marking	On Label:
	"bel", "C2Q", "Current Rating", "Voltage Rating", "Interrupting Rating", "Appropriate Safety Logos" and ", "



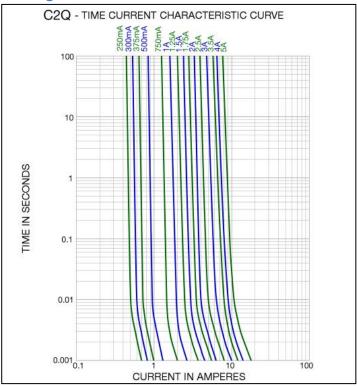
Specifications subject to change without notice

Type C2Q

## **Temperature Derating Curve**



## **Average Time Current Curve**



## **Electrical Specifications**

	_						
Catalog Number	Ampere Rating Resistance		Nominal Volt-drop @100% In	Voltage and Interrupting	Nominal Melting I <sup>2</sup> T @10 In	Nominal Power Dissipation @100% In	Agency Approvals
	(A)	(ohms)	(Volt)	Ratings	(A² Sec)	@ 100% III (W)	c <b>91</b> 0s
C2Q 250	250mA	0.77	0.243		0.00001	0.06	Y
C2Q 300	300mA	0.54	0.217		0.00003	0.07	Y
C2Q 375	375mA	0.42	0.196		0.00004	0.07	Y
C2Q 500	500mA	0.28	0.171		0.00015	0.09	Y
C2Q 750	750mA	0.17	0.159		0.0005	0.12	Y
C2Q 1	1A	0.122	0.154	See Table of Safety Approvals on	0.0010	0.15	Y
C2Q 1.25	1.25A	0.092	0.152		0.0018	0.19	Y
C2Q 1.5	1.5A	0.073	0.146	Page 1 for Voltage	0.0025	0.22	Υ
C2Q 1.75	1.75A	0.063	0.144	and associated Interrupting Ratings	0.0044	0.25	Y
C2Q 2	2A	0.053	0.133	, ,	0.0063	0.27	Υ
C2Q 2.5	2.5A	0.042	0.130		0.0074	0.33	Υ
C2Q 3	3A	0.034	0.130		0.018	0.39	Υ
C2Q 3.5	3.5A	0.028	0.131		0.021	0.46	Y
C2Q 4	4A	0.023	0.131		0.042	0.52	Y
C2Q 5	5A	0.019	0.131		0.055	0.66	Υ

Consult manufacturer for other ratings



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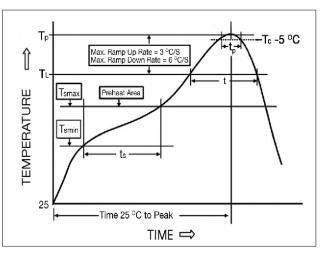
Bel Fuse Inc. 206 Van Vorst Street Jersey City, NJ 07302 USA +1 201.432.0463 Bel.US.CS@belf.com belfuse.com/circuit-protection Type C2Q

## **Environmental Specifications**

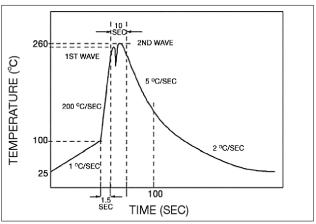
Shock Resistance	MIL-STD-202G, Method 213B, Test Condition 1 (100 G's peak for 6 milliseconds; Sawtooth waveform)	
Vibration Resistance	MIL-STD-202G, Method 201A (10-55 Hz, 0.06 inch, total excursion).	
Salt Spray Resistance	MIL-STD-202G, Method 101E, Test Condition B (48 hrs.).	
Insulation Resistance	MIL-STD-202G, Method 302, Test Condition A (After Opening) 10,000 ohms minimum.	
Solderability	MIL-STD-202G, Method 208H	
Resistance to solder Heat	MIL-STD-202G, Method 210F, Test Condition C. Top Side (260℃,20 sec) MIL-STD-202G, Method 210F, Test Condition D. Bottom Side (260℃,10 sec)	
Thermal Shock	MIL-STD-202G, Method 107G, Test Condition B $(-65^{\circ}\text{C} \text{ to } +125^{\circ}\text{C})$ .	
Operating Temperature	-55℃ to +125℃	
Moisture Sensitivity Level	1 (According to IPC J-Std-020)	

#### **Soldering Parameters**

IR Reflow Profile (IPC/JEDEC J-STD-020D)			
Preheat & Soak Temperature min (T <sub>smin</sub> ) Temperature max (T <sub>smax</sub> ) Time (T <sub>smin</sub> to T <sub>smax</sub> ) (t <sub>s</sub> )	150°C 200°C 60-120 seconds		
Average ramp-up rate (T <sub>smax</sub> to T <sub>p</sub> )	3°C/second max.		
Liquidous temperature (T <sub>L</sub> ) Time at liquidous (t <sub>L</sub> )	217℃ 60-150 seconds		
Peak temperature (T <sub>p</sub> )	260°C max		
Time (tp) within 5°C of the specified classification temperture (T <sub>c</sub> )	30 seconds		
Average ramp-down rate (T <sub>p</sub> to T <sub>smax</sub> )	6°C/second max.		
Time 25℃ to peak temperature	8 minutes max.		



Lead-free Wave Soldering Profile		
Wave Soldering Parameter		
Average ramp-up rate	200℃ / second	
Heating rate during preheat	typical 1 - 2°C / second Max 4°C / second	
Final preheat temperature	within 125°C of soldering temperature	
Peak temperature Tp	260℃	
Time within +0 °C / -5 °C of actual peak temperature	10 seconds	
Ramp-down rate	5℃ / second max.	





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# Fuse FGNO Explanation 0686 - [XXXX] -XX

#### 0686=C2Q; [XXXX]=Ampere Rating; XX=See Ordering Information as below

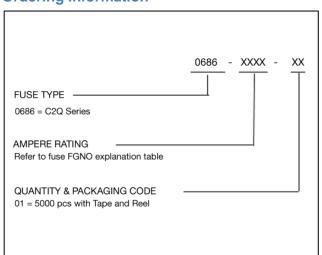
Fraction	Decimal	Milliamps	Bel FGNO[XXXX]
1/4	0.250	250	0250
3/10	.300	300	0300
3/8	.375	375	0375
1/2	.500	500	0500
3/4	.750	750	0750

Fraction	Decimal	Amps	Bel FGNO[XXXX]
	1.0	1	1000
1-1/4	1.25	1.25	1250
1-1/2	1.50	1.5	1500
	1.75	1.75	1750
	2.0	2	2000
2-1/2	2.5	2.5	2500
	3.0	3	3000
3-1/2	3.5	3.5	3500
	4.0	4	4000
	5.0	5	5000

#### **Mechanical Dimensions**

#### 0.82mm±0.15mm (0.032"±0.006") 1.60mm±0.15mpn (0.063"±0.006") Protective Overglaze 0.36mm±0.15mm (0.014"±0.006") Tin Plating Nickel Barrier Silver Metalization Ceramic Substrate C<sub>2</sub>Q 0.76mm (0.03'') 0.76mm (0.03'') 1.09mm (0.043'') 1.27mm (0.05'') 0.91mm 0.76mm (0.030") (0.036'')PAD LAYOUT RECOMMENDED FOR WAVE SOLDER PAD LAYOUT RECOMMENDED FOR INFRARED SOLDER

#### **Ordering Information**



#### **Packaging**

Packaging Tape & Reel	Packaging Specification	Quantity	Quantity & Packaging Code
8 mm wide tape with 7 inches Diameter reel	EIA Standard 481-E	5000	0686-XXXX-01



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